IGBT - Field Stop II

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- These are Pb–Free Devices

Typical Applications

- Solar Inverter
- Uninterruptible Power Inverter Supplies (UPS)
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	50 25	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	100	A
Gate-emitter voltage Transient gate-emitter voltage ($T_{pulse} = 5 \ \mu s, \ D < 0.10$)	V_{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	385 192	W
Short Circuit Withstand Time V _{GE} = 15 V, V _{CE} = 500 V, T _J \leq 150°C	T _{SC}	10	μS
Operating junction temperature range	ТJ	-55 to +175	°C
Storage temperature range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

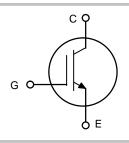
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

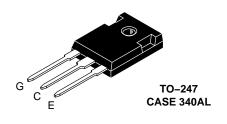


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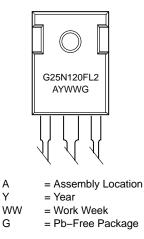
http://onsemi.com

25 A, 1200 V V_{CEsat} = 2.0 V E_{off} = 0.60 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTG25N120FL2WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.39	°C/W
Thermal resistance junction-to-ambient	R_{\thetaJA}	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

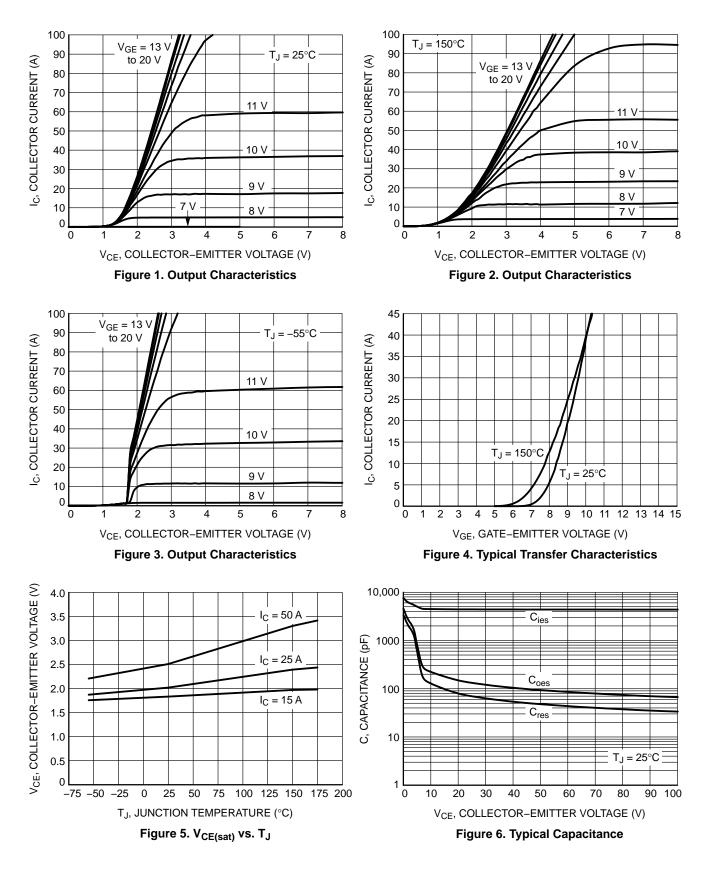
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	-			-	-	-
Collector–emitter breakdown voltage, gate–emitter short–circuited	$V_{GE} = 0 V, I_{C} = 500 \mu A$	V _{(BR)CES}	1200	_	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 25 A V _{GE} = 15 V, I _C = 25 A, T _J = 175°C	V _{CEsat}		2.00 2.40	2.40	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V _{GE} = 0 V, V _{CE} = 1200 V V _{GE} = 0 V, V _{CE} = 1200 V, T _J = 175°C	I _{CES}		- -	0.4 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$, $V_{CE} = 0 \text{ V}$	I _{GES}	-	-	200	nA

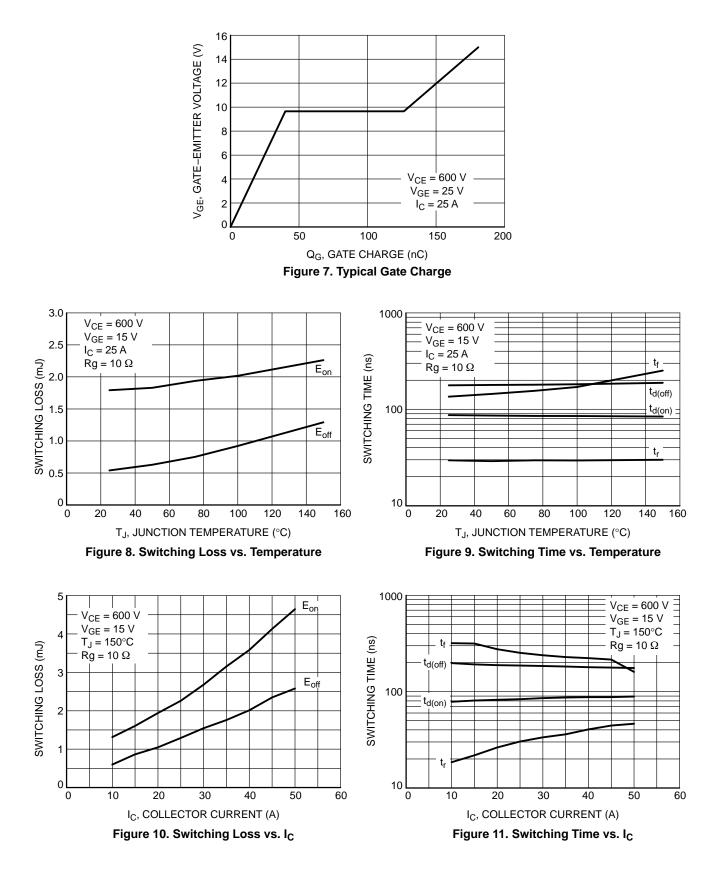
Input capacitance		Cies	-	4420	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	151	-	
Reverse transfer capacitance		C _{res}	-	81	-	
Gate charge total		Qg	-	178	-	nC
Gate to emitter charge	V_{CE} = 600 V, I_{C} = 25 A, V_{GE} = 15 V	Q _{ge}	-	39	-	
Gate to collector charge		Q _{gc}	-	83	-	

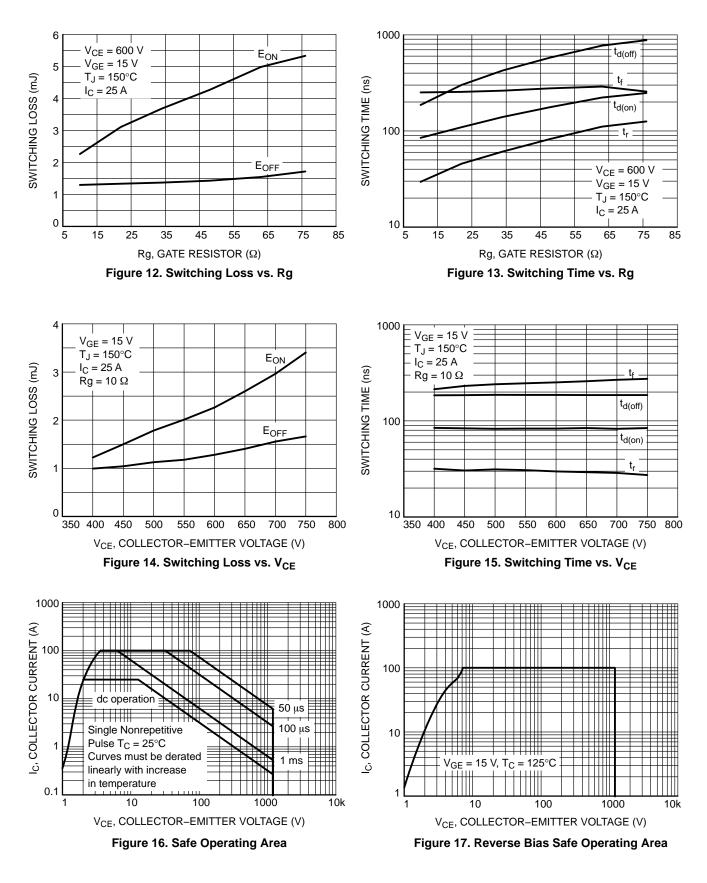
SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

Turn-on delay time		t _{d(on)}	-	87	-	ns
Rise time		t _r	-	74	-	1
Turn–off delay time	T _J = 25°C	t _{d(off)}	-	179	-	1
Fall time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V, I}_{C} = 25 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}^{*}$	t _f	-	136	-	1
Turn-on switching loss	$V_{GE} = 0 V/15V^*$	Eon	-	1.95	-	mJ
Turn-off switching loss		E _{off}	-	0.60	-	1
Total switching loss		E _{ts}	-	2.55	-	1
Turn-on delay time		t _{d(on)}	-	84	-	ns
Rise time		t _r	-	94	-	1
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	185	-	1
Fall time	$T_{J} = 150^{\circ}C$ $V_{CC} = 600 \text{ V, I}_{C} = 25 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15\text{ V}^{*}$	t _f	-	245	-	1
Turn-on switching loss	$V_{GE} = 0 V/15V^*$	Eon	-	2.39	-	mJ
Turn-off switching loss		E _{off}	-	1.26	-	1
Total switching loss		E _{ts}	-	3.65	-	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. *Includes diode reverse recovery loss using NGTB25N120FL2WG.







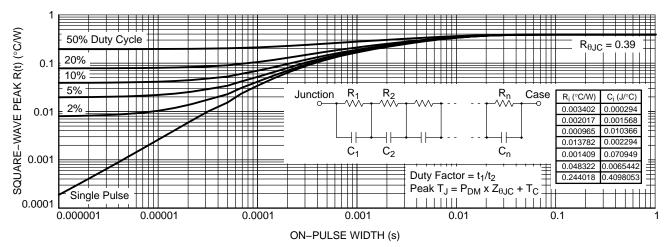


Figure 18. IGBT Die Self-heating Square-wave Duty Cycle Transient Thermal Response

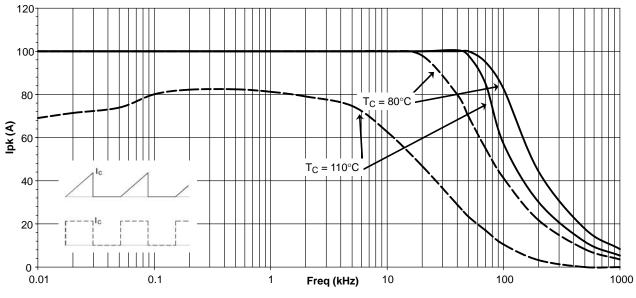


Figure 19. Collector Current vs. Switching Frequency

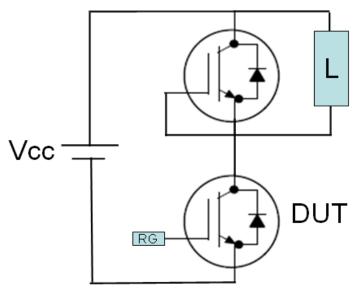
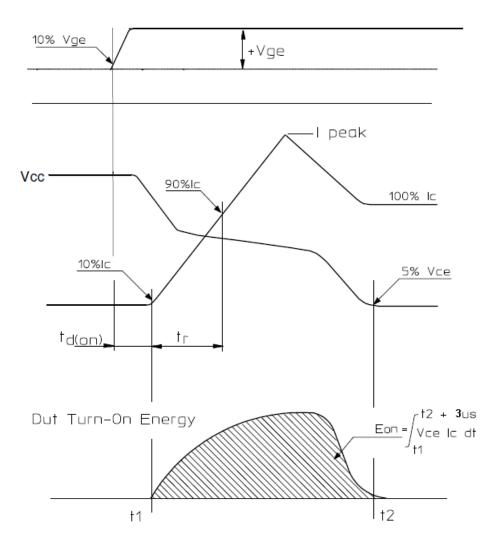
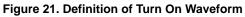


Figure 20. Test Circuit for Switching Characteristics





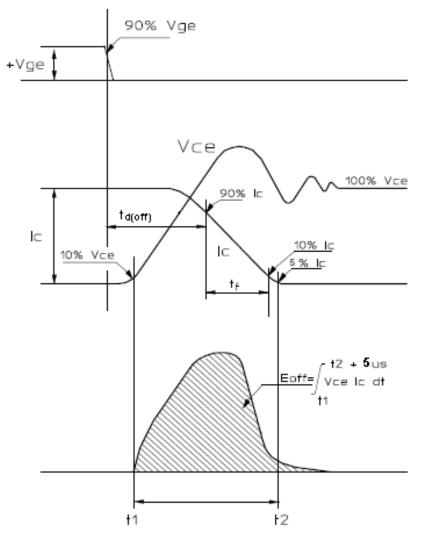
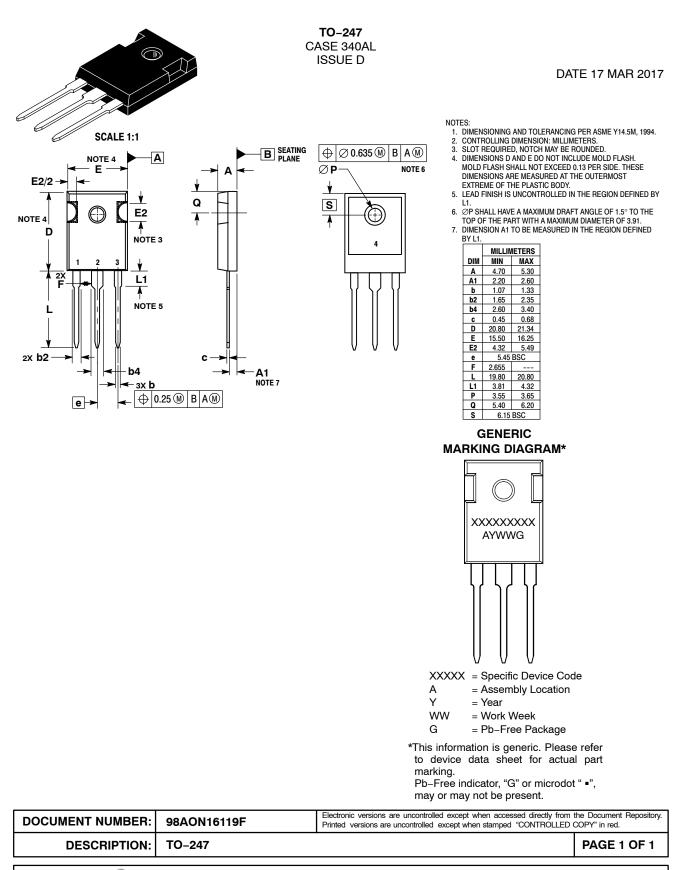


Figure 22. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





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